

SCCS055 - August 1994 - Revised March 2000

# 16-Bit Registers

#### **Features**

- FCT-E speed at 3.7 ns
- · Power-off disable outputs permits live insertion
- Edge-rate control circuitry for significantly improved noise characteristics
- Typical output skew < 250 ps
- ESD > 2000V
- TSSOP (19.6-mil pitch) and SSOP (25-mil pitch) packages
- Industrial temperature range of -40°C to +85°C
- $V_{CC} = 5V \pm 10\%$

#### CY74FCT16374T Features:

- 64 mA sink current, 32 mA source current
- Typical  $V_{OLP}$  (ground bounce) <1.0V at  $V_{CC}$  = 5V,  $T_A$  = 25°C

#### CY74FCT162374T Features:

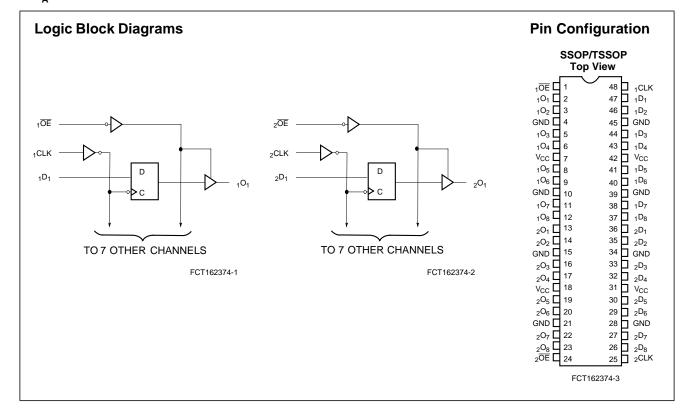
- · Balanced 24 mA output drivers
- Reduced system switching noise
- Typical V<sub>OLP</sub> (ground bounce) <0.6V at V<sub>CC</sub> = 5V, T<sub>A</sub>= 25°C

### **Functional Description**

CY74FCT16374T and CY74FCT162374T are 16-bit D-type registers designed for use as buffered registers in high-speed, low power bus applications. These devices can be used as two independent 8-bit registers or as a single 16-bit register by connecting the output Enable (OE) and Clock (CLK) inputs. Flow-through pinout and small shrink packaging aid in simplifying board layout. The output buffers are designed with power-off disable feature that allows live insertion of boards.

The CY74FCT16374T is ideally suited for driving high-capacitance loads and low-impedance backplanes.

The CY74FCT162374T has 24-mA balanced output drivers with current limiting resistors in the outputs. This reduces the need for external terminating resistors and provides for minimal undershoot and reduced ground bounce. The CY74FCT162374T is ideal for driving transmission lines.





### Function Table<sup>[1]</sup>

	Inputs		Outputs	
D	CLK	OE	0	Function
Х	L	Н	Z	High-Z
Х	Н	Н	Z	
L	7	L	L	Load
Н	7	L	Н	Register
L	7	Н	Z	
Н	7	Н	Z	

## **Pin Description**

Name	Description					
D	Data Inputs					
CLK	Clock Inputs					
ŌĒ	Three-State Output Enable Inputs (Active LOW)					
0	Three-State Outputs					

## Maximum Ratings<sup>[2, 3]</sup>

(Above which the useful life may be impaired. For user guidelines, not tested.)
Storage Temperature –55°C to +125°C
Ambient Temperature with Power Applied
DC Input Voltage0.5V to +7.0V
DC Output Voltage0.5V to +7.0V
DC Output Current (Maximum Sink Current/Pin)60 to +120 mA
Power Dissipation1.0W
Static Discharge Voltage>2001V (per MIL-STD-883, Method 3015)

## **Operating Range**

Range	Ambient Temperature	V <sub>CC</sub>
Industrial	-40°C to +85°C	5V ± 10%

## **Electrical Characteristics** Over the Operating Range

Parameter	Description	Test Conditions	Min.	Typ. <sup>[4]</sup>	Max.	Unit
V <sub>IH</sub>	Input HIGH Voltage		2.0			V
V <sub>IL</sub>	Input LOW Voltage				0.8	V
V <sub>H</sub>	Input Hysteresis <sup>[5]</sup>			100		mV
V <sub>IK</sub>	Input Clamp Diode Voltage	V <sub>CC</sub> =Min., I <sub>IN</sub> =-18 mA		-0.7	-1.2	V
I <sub>IH</sub>	Input HIGH Current	V <sub>CC</sub> =Max., V <sub>I</sub> =V <sub>CC</sub>			±1	μΑ
I <sub>IL</sub>	Input LOW Current	V <sub>CC</sub> =Max., V <sub>I</sub> =GND			±1	μΑ
I <sub>OZH</sub>	High Impedance Output Current (Three-State Output pins)	V <sub>CC</sub> =Max., V <sub>OUT</sub> =2.7V			±1	μА
I <sub>OZL</sub>	High Impedance Output Current (Three-State Output pins)	V <sub>CC</sub> =Max., V <sub>OUT</sub> =0.5V			±1	μА
Ios	Short Circuit Current <sup>[6]</sup>	V <sub>CC</sub> =Max., V <sub>OUT</sub> =GND	-80	-140	-200	mA
I <sub>O</sub>	Output Drive Current <sup>[6]</sup>	V <sub>CC</sub> =Max., V <sub>OUT</sub> =2.5V	-50		-180	mA
I <sub>OFF</sub>	Power-Off Disable	V <sub>CC</sub> =0V, V <sub>OUT</sub> ≤4.5V <sup>[7]</sup>		·	±1	μΑ

## **Output Drive Characteristics for CY74FCT16374T**

Parameter	Description	Test Conditions	Min.	Typ. <sup>[4]</sup>	Max.	Unit
V <sub>OH</sub>	Output HIGH Voltage	V <sub>CC</sub> =Min., I <sub>OH</sub> =-3 mA	2.5	3.5		V
		V <sub>CC</sub> =Min., I <sub>OH</sub> =-15 mA	2.4	3.5		V
		V <sub>CC</sub> =Min., I <sub>OH</sub> =-32 mA	2.0	3.0		V
V <sub>OL</sub>	Output LOW Voltage	V <sub>CC</sub> =Min., I <sub>OL</sub> =64 mA		0.2	0.55	V

#### Notes:



## **Output Drive Characteristics for CY74FCT162374T**

Parameter	Description	Test Conditions	Min.	<b>Typ.</b> <sup>[4]</sup>	Max.	Unit
I <sub>ODL</sub>	Output LOW Current <sup>[6]</sup>	V <sub>CC</sub> =5V, V <sub>IN</sub> =V <sub>IH</sub> or V <sub>IL</sub> , V <sub>OUT</sub> =1.5V	60	115	150	mA
I <sub>ODH</sub>	Output HIGH Current <sup>[6]</sup>	V <sub>CC</sub> =5V, V <sub>IN</sub> =V <sub>IH</sub> or V <sub>IL</sub> , V <sub>OUT</sub> =1.5V	-60	-115	-150	mA
V <sub>OH</sub>	Output HIGH Voltage	V <sub>CC</sub> =Min., I <sub>OH</sub> =–24 mA	2.4	3.3		V
V <sub>OL</sub>	Output LOW Voltage	V <sub>CC</sub> =Min., I <sub>OL</sub> =24 mA		0.3	0.55	V

## **Capacitance**<sup>[5]</sup> ( $T_A = +25^{\circ}C$ , f = 1.0 MHz)

Parameter	Description	Test Conditions	Typ. <sup>[4]</sup>	Max.	Unit
C <sub>IN</sub>	Input Capacitance	$V_{IN} = 0V$	4.5	6.0	pF
C <sub>OUT</sub>	Output Capacitance	V <sub>OUT</sub> = 0V	5.5	8.0	pF

## **Power Supply Characteristics**

Parameter	Description	Test Condition	ons	Typ. <sup>[4]</sup>	Max.	Unit
Icc	Quiescent Power Supply Current	V <sub>CC</sub> =Max.	V <sub>IN</sub> ≤0.2V, V <sub>IN</sub> ≥V <sub>CC</sub> −0.2V	5	500	μΑ
Δl <sub>CC</sub>	Quiescent Power Supply Current (TTL inputs HIGH)	V <sub>CC</sub> =Max.	V <sub>IN</sub> =3.4V <sup>[8]</sup>	0.5	1.5	mA
I <sub>CCD</sub>	Dynamic Power Supply Current <sup>[9]</sup>	V <sub>CC</sub> =Max., One Input Toggling, 50% <u>Duty</u> Cycle, Outputs Open, <del>OE</del> =GND	V <sub>IN</sub> =V <sub>CC</sub> or V <sub>IN</sub> =GND	60	100	μΑ/ MHz
Ic	Total Power Supply Current <sup>[10]</sup>	V <sub>CC</sub> =Max., f <sub>0</sub> =10 MHz, f <sub>1</sub> =5 MHz, 50% Duty Cycle,	V <sub>IN</sub> =V <sub>CC</sub> or V <sub>IN</sub> =GND	0.6	1.5	mA
		Outputs Open, One Bit Toggling, OE=GND	V <sub>IN</sub> =3.4V or V <sub>IN</sub> =GND	1.1	3.0	mA
		V <sub>CC</sub> =Max., f <sub>0</sub> =10 MHz, f <sub>1</sub> =2.5 MHz, 50% Duty	V <sub>IN</sub> =V <sub>CC</sub> or V <sub>IN</sub> =GND	3.0	5.5 <sup>[11]</sup>	mA
		Cycle, Outputs Open, Sixteen Bits Toggling, OE=GND	V <sub>IN</sub> =3.4V or V <sub>IN</sub> =GND	7.5	19.0 <sup>[11]</sup>	mA

Note:

8. Per TTL driven input (V<sub>IN</sub>=3.4V); all other inputs at V<sub>CC</sub> or GND.

9. This parameter is not directly testable, but is derived for use in Total Power Supply calculations.

10. I<sub>C</sub> = I<sub>QUIESCENT</sub> + I<sub>INPUTS</sub> + I<sub>DYNAMIC</sub>
I<sub>C</sub> = I<sub>CC</sub>+ΔI<sub>CC</sub>D<sub>H</sub>N<sub>T</sub>+I<sub>CCD</sub>(f<sub>0</sub>/2 + f<sub>1</sub>N<sub>1</sub>)
I<sub>CC</sub> = Quiescent Current with CMOS input levels

ΔI<sub>CC</sub> = Power Supply Current for a TTL HIGH input (V<sub>IN</sub>=3.4V)
D<sub>H</sub> = Duty Cycle for TTL inputs HIGH
N<sub>T</sub> = Number of TTL inputs at D<sub>H</sub>
I<sub>CCD</sub> = Dynamic Current caused by an input transition pair (HLH or LHL)
f<sub>0</sub> = Clock frequency for registered devices, otherwise zero
f<sub>1</sub> = Input signal frequency
N<sub>1</sub> = Number of inputs changing at f<sub>1</sub>

= Number of inputs changing at f<sub>1</sub>

All currents are in milliamps and all frequencies are in megahertz.

11. Values for these conditions are examples of the I<sub>CC</sub> formula. These limits are specified but not tested.



## **Switching Characteristics** Over the Operating Range<sup>[12]</sup>

			CY74FCT16374T CY74FCT162374T		CY74FCT16374AT CY74FCT162374AT		Fig
Parameter	Description	Min.	Max.	Min.	Max.	Unit	Fig. No. <sup>[13]</sup>
t <sub>PLH</sub> t <sub>PHL</sub>	Propagation Delay CLK to O	2.0	10.0	2.0	6.5	ns	1, 5
t <sub>PZH</sub>	Output Enable Time	1.5	12.5	1.5	6.5	ns	1, 7, 8
t <sub>PHZ</sub>	Output Disable Time	1.5	8.0	1.5	5.5	ns	1, 7, 8
t <sub>SU</sub>	Set-Up Time HIGH or LOW, D to CLK	2.0		2.0		ns	4
t <sub>H</sub>	Hold Time HIGH or LOW, D to CLK	1.5		1.5		ns	4
t <sub>W</sub>	CLK Pulse Width HIGH or LOW	5.0		5.0		ns	5
t <sub>SK(O)</sub>	Output Skew <sup>[14]</sup>		0.5		0.5	ns	

			T16374CT [162374CT		T16374ET 162374ET		Fig
Parameter	Description	Min.	Max.	Min.	Max.	Unit	Fig. No. <sup>[13]</sup>
t <sub>PLH</sub> t <sub>PHL</sub>	Propagation Delay CLK to O	2.0	5.2	2.0	3.7	ns	1, 5
t <sub>PZH</sub>	Output Enable Time	1.5	5.5	1.5	4.4	ns	1, 7, 8
t <sub>PHZ</sub>	Output Disable Time	1.5	5.0	1.5	3.6	ns	1, 7, 8
t <sub>SU</sub>	Set-Up Time HIGH or LOW, D to CLK	2.0		1.5		ns	4
t <sub>H</sub>	Hold Time HIGH or LOW, D to CLK	1.5		0.0		ns	4
t <sub>W</sub>	CLK Pulse Width HIGH or LOW	3.3		3.0		ns	5
t <sub>SK(O)</sub>	Output Skew <sup>[14]</sup>		0.5		0.5	ns	

Minimum limits are specified but not tested on Propagation Delays.
 See "Parameter Measurement Information" in the General Information section.
 Skew between any two outputs of the same package switching in the same direction. This parameter is ensured by design.



## Ordering Information CY74FCT16374T

Speed (ns)	Ordering Code	Package Name	Package Type	Operating Range
3.7	CY74FCT16374ETPACT	Z48	48-Lead (240-Mil) TSSOP	Industrial
	CY74FCT16374ETPVC/PVCT	O48	48-Lead (300-Mil) SSOP	
5.2	CY74FCT16374CTPACT	Z48	48-Lead (240-Mil) TSSOP	Industrial
	CY74FCT16374CTPVC/PVCT	O48	48-Lead (300-Mil) SSOP	
6.5	CY74FCT16374ATPACT	Z48	48-Lead (240-Mil) TSSOP	Industrial
	CY74FCT16374ATPVC/PVCT	O48	48-Lead (300-Mil) SSOP	
10.0	CY74FCT16374TPVC/PVCT	O48	48-Lead (300-Mil) SSOP	Industrial

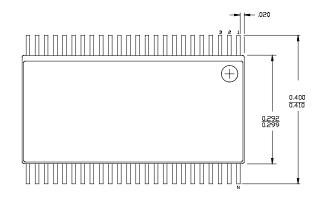
# Ordering Information CY74FCT162374T

Speed (ns)	Ordering Code	Package Name	Package Type	Operating Range
3.7	74FCT162374ETPACT	Z48	48-Lead (240-Mil) TSSOP	Industrial
	CY74FCT162374ETPVC	O48	48-Lead (300-Mil) SSOP	
	74FCT162374ETPVCT	O48	48-Lead (300-Mil) SSOP	
5.2	74FCT162374CTPACT	Z48	48-Lead (240-Mil) TSSOP	Industrial
	CY74FCT162374CTPVC	O48	48-Lead (300-Mil) SSOP	
	74FCT162374CTPVCT	O48	48-Lead (300-Mil) SSOP	
6.5	74FCT162374ATPACT	Z48	48-Lead (240-Mil) TSSOP	Industrial
	CY74FCT162374ATPVC	O48	48-Lead (300-Mil) SSOP	
	74FCT162374ATPVCT	O48	48-Lead (300-Mil) SSOP	
10.0	CY74FCT162374TPVC/PVCT	O48	48-Lead (300-Mil) SSOP	Industrial

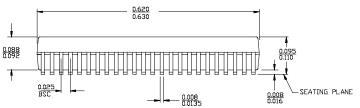


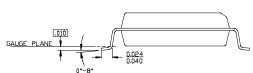
## **Package Diagrams**

## 48-Lead Shrunk Small Outline Package O48

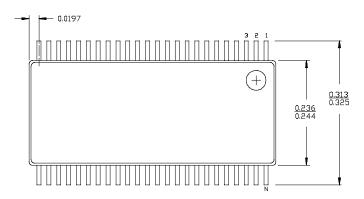


DIMENSIONS IN INCHES MIN. MAX.

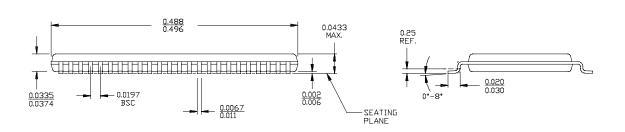




## 48-Lead Thin Shrunk Small Outline Package Z48



DIMENSIONS IN INCHES MIN. MAX.



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